



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Yoram Uziel et al.)
Application No. 09/721,167)
Filed: November 22, 2000) Group Art Unit: 1763
For: IN SITU MODULE FOR PARTICLE)
REMOVAL FROM SOLID-STATE)
SURFACES)
Examiner: Parviz Hassanzadeh) Attorney Docket No. STC-38090

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AMENDMENT

Commissioner for Patents
Washington, D. C. 20231

Sir:

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In response to an Official Action dated September 11, 2002, kindly amend the above-referenced application as follows:

IN THE FIGURES:

Amended Figs. 3, 4 and 5 (now labeled Fig. 5A) are submitted herewith, showing proposed corrections to the drawings. A new Fig. 5B is submitted herewith, as well, as discussed in the remarks below.

IN THE SPECIFICATION:

Kindly amend the following paragraphs of the specification, so that they read as follows. A marked-up version of the amended specification paragraphs is attached hereto.

Please replace the paragraph beginning at page 8, line 20, with the following rewritten paragraph:

-- Fig. 5A is a schematic, sectional view of a cleaning module for removal of particles from a substrate during a manufacturing process, in accordance with a preferred embodiment of the present invention; --

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